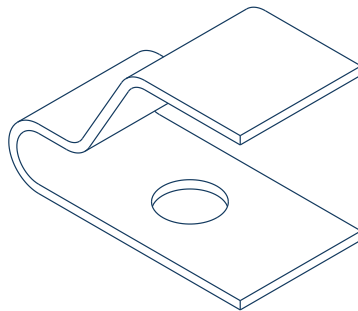




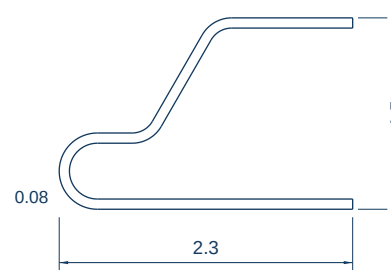
Type C-04 BC04-12023015

SMD EMI Spring Contact | Beryllium Copper | Units: mm

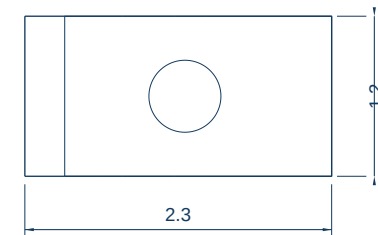
Isometric



Front view (mm)



Top view (mm)



MECHANICAL

VALUE

Thickness	0.08 mm
Width	1.2 mm +/- 0.2
Length	2.3 mm +/- 0.2
Height	1.5 mm +/- 0.2
Bottom flat	2.04 mm
Top flat	1.00 mm
End curl	R0.259 CL, 180 deg
Spring beam	60.1 deg
Knee bends	R0.224 / R0.227 CL
Base hole	dia 0.54 mm at 1.20 from curl end
Material / plating	BeCu, Gold-plated (G)
Volume / mass	0.489 mm ³ 4.1 mg (BeCu)
File format	STEP AP214

PRODUCT DATA

VALUE

Mfr P/N	BC04-12023015G-SY (Au)
Brand	Seyunda
Description	SMD EMI Contact 2.3x1.2x1.5mm
Packaging	Tape & Reel (TR)
Category	Connectors, Interconnects
Sub-category	Contacts, Spring Loaded (Pogo Pins), and Pressure
Lifecycle / origin	Active / Taiwan, Republic of China
RoHS / REACH	RoHS Compliant / REACH Unaffected
ECCN / ESD	EAR99 / Static sensitive: Yes
Datasheet	seyunda.com/datasheet/Seyunda-SMD-Spring-Contacts-Datasheet.pdf
Product page	seyunda.com/type-c-04.html